

Precision 16-Channel/Dual 8-Channel CMOS Analog Multiplexers

DESCRIPTION

The DG506B and DG507B are high performance analog multiplexers. Their ultra-low switch charge injection, low channel capacitance, and low leakage level allows them to achieve superior switching performance. The DG506B is a 16-channel single-ended analog multiplexer designed to connect one of sixteen inputs to a common output as determined by a 4-bit binary address (A0, A1, A2, A3). The DG507B is a dual 8-channel differential analog multiplexer designed to connect one of eight differential inputs to a common dual output as determined by its 3-bit binary address (A0, A1, A2). Break-before-make switching action protects against momentary crosstalk between adjacent channels.

An on channel conducts current equally well in both directions. In the off state each channel blocks voltages up to the power supply rails. An enable (EN) function allows the user to reset the multiplexer/demultiplexer to all switches off for stacking several devices. All control inputs, addresses (Ax) and enable (EN) are TTL compatible over the full specified operating temperature range.

The DG506B and DG507B are fabricated on an enhanced SG-II CMOS process that achieves improved performance on: reduced charge injection, lower device leakage, and minimized parasitic capacitance.

As the DG506, DG507 has a long history in the industry with many suppliers offering copies, and in some cases improved variations, with the best in class improvements, the Vishay Siliconix new version of the DG506B, DG507B are the superior alternatives to what is currently available.

Applications for the DG506B, DG507B include high speed and high precision data acquisition, audio signal switching and routing, ATE systems, and avionics. High performance and low power dissipation make them ideal for battery operated and remote instrumentation applications.

The DG506B and DG507B have the absolute maximum voltage rating extended to 44 V. Additionally, single supply operation is also allowed. An epitaxial layer prevents latch-up.

The DG506B and DG507B are both available in 28-lead SOIC and TSSOP package options with extended temperature range of -40 °C to +125 °C.

For more information, refer to Vishay Siliconix DG506B, DG507B evaluation board note.

FEATURES

- Operate with single or dual power supply
- V+ to V- analog signal swing range
- 44 V power supply maximum rating
- Extended operate temperature range: -40 °C to +125 °C
- Low leakage typically < 3 pA
- Low charge injection - $Q_{INJ} = 1$ pC
- Low power - $I_{SUPPLY}: 5$ μ A
- TTL compatible logic
- > 250 mA latch up current per JESD78
- Available in SOIC28 and TSSOP28 packages
- Superior alternative to:
 - ADG506A, DG506A, HI-506
 - ADG507A, DG507A, HI-507
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

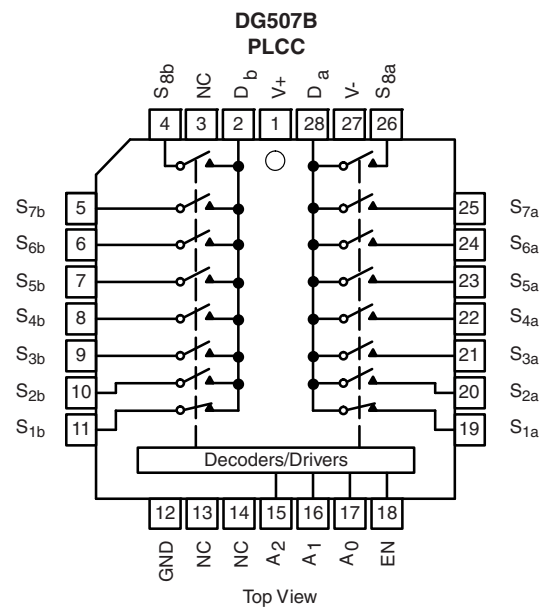
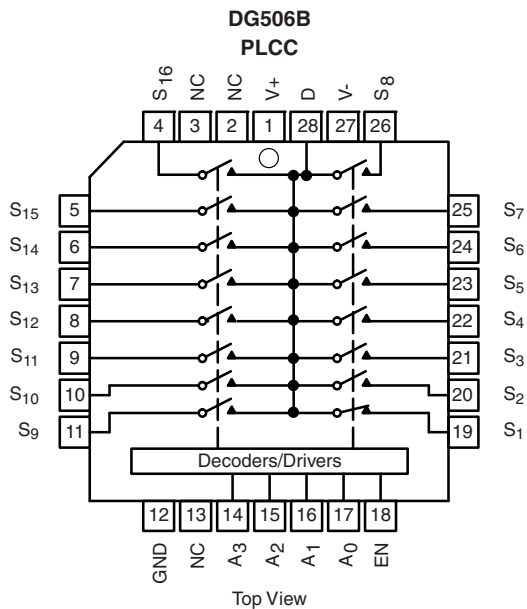
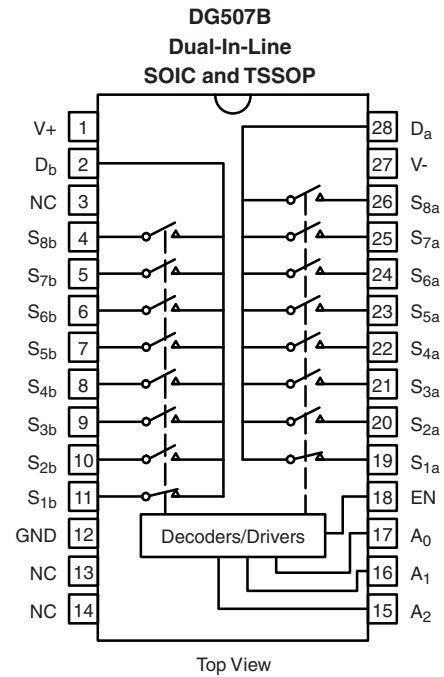
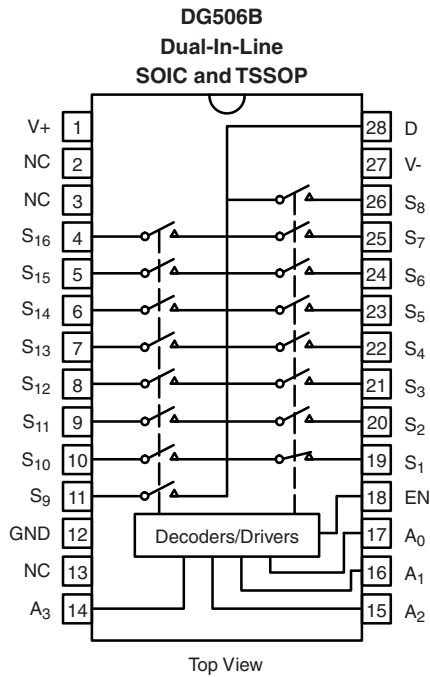
BENEFITS

- Reduced switching errors
- Reduced glitching
- Improved data throughput
- Reduced power consumption
- Increased ruggedness
- Wide supply ranges (± 5 V to ± 20 V)

APPLICATIONS

- Data acquisition systems
- Audio and video signal routing
- ATE systems
- Medical instrumentation

FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION





| TRUTH TABLE DG506B | | | | | |
|--------------------|----------------|----------------|----------------|----|-----------|
| A ₃ | A ₂ | A ₁ | A ₀ | EN | On Switch |
| X | X | X | X | 0 | None |
| 0 | 0 | 0 | 0 | 1 | 1 |
| 0 | 0 | 0 | 1 | 1 | 2 |
| 0 | 0 | 1 | 0 | 1 | 3 |
| 0 | 0 | 1 | 1 | 1 | 4 |
| 0 | 1 | 0 | 0 | 1 | 5 |
| 0 | 1 | 0 | 1 | 1 | 6 |
| 0 | 1 | 1 | 0 | 1 | 7 |
| 1 | 1 | 1 | 1 | 1 | 8 |
| 1 | 0 | 0 | 0 | 1 | 9 |
| 1 | 0 | 0 | 1 | 1 | 10 |
| 1 | 0 | 1 | 0 | 1 | 11 |
| 1 | 0 | 1 | 1 | 1 | 12 |
| 1 | 1 | 0 | 0 | 1 | 13 |
| 1 | 1 | 0 | 1 | 1 | 14 |
| 1 | 1 | 1 | 0 | 1 | 15 |
| 1 | 1 | 1 | 1 | 1 | 16 |

| TRUTH TABLE DG507B | | | | |
|--------------------|----------------|----------------|----|-----------|
| A ₂ | A ₁ | A ₀ | EN | On Switch |
| X | X | X | 0 | None |
| 0 | 0 | 0 | 1 | 1 |
| 0 | 0 | 1 | 1 | 2 |
| 0 | 1 | 0 | 1 | 3 |
| 0 | 1 | 1 | 1 | 4 |
| 1 | 0 | 0 | 1 | 5 |
| 1 | 0 | 1 | 1 | 6 |
| 1 | 1 | 0 | 1 | 7 |
| 1 | 1 | 1 | 1 | 8 |

Logic "0" = $V_{IL} \leq 0.8 V$
 Logic "1" = $V_{IH} \geq 2.4 V$
 X = Do not care

| ORDERING INFORMATION DG506B | | |
|-----------------------------|--------------|-----------------|
| Temp. Range | Package | Part Number |
| -40 °C to 125 °C | 28-Pin SOIC | DG506BEW-T1-GE3 |
| | 28-Pin TSSOP | DG506BEQ-T1-GE3 |
| | 28-Pin PLCC | DG506BEN-T1-GE3 |

| ORDERING INFORMATION DG507B | | |
|-----------------------------|--------------|-----------------|
| Temp. Range | Package | Part Number |
| -40 °C to 125 °C | 28-Pin SOIC | DG507BEW-T1-GE3 |
| | 28-Pin TSSOP | DG507BEQ-T1-GE3 |
| | 28-Pin PLCC | DG507BEN-T1-GE3 |

| ABSOLUTE MAXIMUM RATINGS | | | |
|---|------------------------------------|--|------|
| Parameter | | Limit | Unit |
| Voltages Referenced to V- | V+ | 44 | V |
| | GND | 25 | |
| Digital Inputs ^a , V _S , V _D | | (V-) - 2 to (V+) + 2 or 20 mA, whichever occurs first | |
| Current (Any terminal) | | 30 | mA |
| Peak Current, S or D (Pulsed at 1 ms, 10 % duty cycle max.) | | 100 | |
| Storage Temperature | (EW, EQ, EN suffix) | -65 to 150 | °C |
| Power Dissipation (Packages) ^b | 28-Pin Wide Body SOIC ^c | 840 | mW |
| | 28-Pin TSSOP ^d | 817 | |
| | 28-Pin PLCC ^e | 1693 | |
| Thermal Resistance (θ_{J-A}) ^b | 28-Pin Wide Body SOIC ^c | 95.3 | °C/W |
| | 28-Pin TSSOP ^d | 97.9 | |
| | 28-Pin PLCC ^e | 47.3 | |

Notes:

- a. Signals on S_X, D_X or IN_X exceeding V+ or V- will be clamped by internal diodes. Limit forward diode current to maximum current ratings.
- b. All leads soldered or welded to PC board.
- c. Derate 10.5 mW/°C above 70 °C.
- d. Derate 10.2 mW/°C above 70 °C.
- e. Derate 21.2 mW/°C above 70 °C.

| SPECIFICATIONS | | | | | | | | | | |
|--|---------------------|---|--------------------|-------------------|------------------------------|-------------------|-----------------------------|-------------------|---------------|---|
| Parameter | Symbol | Test Conditions Unless Otherwise Specified $V_+ = 15\text{ V}$, $V_- = -15\text{ V}$ ($\pm 10\%$) V_{AX} , $V_{EN} = 2.4\text{ V}$, 0.8 V^a | Temp. ^b | Typ. ^c | A Suffix -40 °C to 125 °C | | D Suffix -40 °C to 85 °C | | Unit | |
| | | | | | Min. ^d | Max. ^d | Min. ^d | Max. ^d | | |
| Analog Switch | | | | | | | | | | |
| Analog Signal Range ^e | V_{ANALOG} | | Full | | -15 | 15 | -15 | 15 | V | |
| Drain-Source On-Resistance | $R_{DS(on)}$ | $V_D = \pm 10\text{ V}$, $I_S = -1\text{ mA}$ | Room | 170 | | 300 | | 300 | Ω | |
| | | | Full | | | 400 | | 400 | | |
| $R_{DS(on)}$ Matching | $\Delta R_{DS(on)}$ | $V_D = \pm 10\text{ V}$ | Room | 10 | | | | | | |
| Source Off Leakage Current | $I_{S(off)}$ | $V_D = \pm 10\text{ V}$ $V_S = \mp 10\text{ V}$ $V_{EN} = 0\text{ V}$ | Room | 0.005 | -1 | 1 | -1 | 1 | nA | |
| Drain Off Leakage Current | $I_{D(off)}$ | | DG506B | Room | 0.005 | -1 | 1 | -1 | | 1 |
| | | | DG507B | Room | 0.005 | -1 | 1 | -1 | | 1 |
| Drain On Leakage Current | $I_{D(on)}$ | | DG506B | Room | 0.005 | -1 | 1 | -1 | | 1 |
| | | DG507B | Room | 0.005 | -1 | 1 | -1 | 1 | | |
| Digital Control | | | | | | | | | | |
| Logic High Input Voltage | V_{INH} | | Full | | 2.4 | | 2.4 | | V | |
| Logic Low Input Voltage | V_{INL} | | Full | | | 0.8 | | 0.8 | | |
| Logic High Input Current | I_{IH} | V_{AX} , $V_{EN} = 2.4\text{ V}$ | Full | | -1 | 1 | -1 | 1 | μA | |
| Logic Low Input Current | I_{IL} | V_{AX} , $V_{EN} = 0.8\text{ V}$ | Full | | -1 | 1 | -1 | 1 | | |
| Logic Input Capacitance ^e | C_{in} | $f = 1\text{ MHz}$ | Room | 5 | | | | | pF | |
| Dynamic Characteristics | | | | | | | | | | |
| Transition Time | t_{TRANS} | $V_{S1} = +10\text{ V}/-10\text{ V}$, $V_{S16} = -10\text{ V}/+10\text{ V}$, $R_L = 1\text{ M}\Omega$, $C_L = 35\text{ pF}$ see figure 2 | Room | 190 | | 300 | | 300 | ns | |
| | | | Full | | | 360 | | 360 | | |
| Break-Before-Make Interval | t_{OPEN} | $V_{S1} = V_{S16} = 5.0\text{ V}$, $C_L = 35\text{ pF}$, $R_L = 1\text{ k}\Omega$, see figure 4 | Room | 84 | 30 | | 30 | | ns | |
| | | | Full | | 10 | | 10 | | | |
| Enable Turn-On Time | $t_{ON(EN)}$ | $V_{S1} = 5\text{ V}$, V_{S2} to $V_{S16} = 0\text{ V}$, $R_L = 1\text{ k}\Omega$, $C_L = 35\text{ pF}$ see figure 3 | Room | 151 | | 250 | | 250 | ns | |
| | | | Full | | | 310 | | 310 | | |
| Enable Turn-Off Time | $t_{OFF(EN)}$ | | Room | 53 | | 200 | | 200 | | |
| | | | Full | | | 220 | | 220 | | |
| Charge Injection ^e | Q_{INJ} | $C_L = 1\text{ nF}$, $R_{GEN} = 0\ \Omega$, $V_{GEN} = 0\text{ V}$ | Full | 1 | | | | | pC | |
| Off Isolation ^e | OIRR | $C_L = 5\text{ pF}$, $R_L = 50\ \Omega$, $f = 1\text{ MHz}$ | DG506B | Room | -85 | | | | dB | |
| | | | DG507B | Room | -84 | | | | | |
| Crosstalk ^e | XTALK | $C_L = 5\text{ pF}$, $R_L = 50\ \Omega$, $f = 1\text{ MHz}$ | DG506B | Room | -85 | | | | dB | |
| | | | DG507B | Room | -84 | | | | | |
| -3 dB Bandwidth ^e | BW | $R_L = 50\ \Omega$ | DG506B | Room | 114 | | | | MHz | |
| | | | DG507B | Room | 217 | | | | | |
| Total Harmonic Distortion ^e | THD | $R_L = 10\text{ k}\Omega$, 5 V_{rms} | Room | 0.04 | | | | | % | |
| Source Off Capacitance ^e | $C_{S(off)}$ | $f = 1\text{ MHz}$ | Room | 3 | | | | | pF | |
| Drain Off Capacitance ^e | $C_{D(off)}$ | | DG506B | Room | 31 | | | | | |
| | | | DG507B | Room | 17 | | | | | |
| Drain On Capacitance ^e | $C_{D(on)}$ | | DG506B | Room | 38 | | | | | |
| | | DG507B | Room | 24 | | | | | | |
| Power Supply | | | | | | | | | | |
| Positive Supply Current | I_+ | V_{AX} , $V_{EN} = 0\text{ V}$ or 5 V | Room | 0.005 | | 0.1 | | 0.1 | mA | |
| | | | Full | | | 0.1 | | 0.1 | | |
| Negative Supply Current | I_- | | Full | | -1 | | -1 | | μA | |



| SPECIFICATIONS Single Supply 12 V | | | | | | | | | | |
|--|---------------------|---|--------------------|-------------------|------------------------------|-------------------|-----------------------------|-------------------|---------------|------|
| Parameter | Symbol | Test Conditions Unless Otherwise Specified $V_+ = 12\text{ V}$, $V_- = 0\text{ V}$ ($\pm 10\%$) V_{AX} , $V_{EN} = 2.4\text{ V}$, 0.8 V^a | Temp. ^b | Typ. ^c | A Suffix -40 °C to 125 °C | | D Suffix -40 °C to 85 °C | | Unit | |
| | | | | | Min. ^d | Max. ^d | Min. ^d | Max. ^d | | |
| Analog Switch | | | | | | | | | | |
| Analog Signal Range ^e | V_{ANALOG} | | Full | | 0 | 12 | 0 | 12 | V | |
| On-Resistance | $R_{DS(on)}$ | $V_D = 10\text{ V}/0\text{ V}$, $I_S = 1\text{ mA}$ | Room | 270 | | 450 | | 450 | Ω | |
| $R_{DS(on)}$ Matching | $\Delta R_{DS(on)}$ | | Full | | | 650 | | 650 | | |
| Switch Off Leakage Current | $I_{S(off)}$ | $V_+ = 12\text{ V}$, $V_- = 0\text{ V}$ $V_D = 0\text{ V}/10\text{ V}$, $V_S = 10\text{ V}/0\text{ V}$ | Room | 0.005 | -1 | 1 | -1 | 1 | nA | |
| | | | Full | | | -50 | -50 | -50 | | 50 |
| | $I_{D(off)}$ | | DG506B | Room | 0.005 | -1 | 1 | -1 | | 1 |
| | | | Full | | | | -100 | 100 | | -100 |
| | $I_{D(off)}$ | | DG507B | Room | 0.005 | -1 | 1 | -1 | | 1 |
| | | | Full | | | | -50 | 50 | | -50 |
| Channel On Leakage Current | $I_{D(on)}$ | $V_+ = 12\text{ V}$, $V_- = 0\text{ V}$ $V_S = V_D = 0\text{ V}/10\text{ V}$ | DG506B | Room | 0.005 | -1 | 1 | -1 | 1 | |
| | | | Full | | | -100 | 100 | -100 | 100 | |
| | | | DG507B | Room | 0.005 | -1 | 1 | -1 | 1 | |
| | | | Full | | | | | -50 | 50 | -50 |
| Digital Control | | | | | | | | | | |
| Logic High Input Voltage | V_{INH} | | Full | | 2.4 | | 2.4 | | V | |
| Logic Low Input Voltage | V_{INL} | | Full | | | 0.8 | | 0.8 | | |
| Logic High Input Current | I_{IH} | V_{AX} , $V_{EN} = 2.4\text{ V}$ | Full | | -1 | 1 | -1 | 1 | μA | |
| Logic Low Input Current | I_{IL} | V_{AX} , $V_{EN} = 0.8\text{ V}$ | Full | | -1 | 1 | -1 | 1 | | |
| Logic Input Capacitance ^e | C_{in} | $f = 1\text{ MHz}$ | Room | 5 | | | | | pF | |
| Dynamic Characteristics | | | | | | | | | | |
| Transition Time | t_{TRANS} | $V_{S1} = 10\text{ V}/0\text{ V}$, $V_{S16} = 0\text{ V}/10\text{ V}$, $R_L = 1\text{ M}\Omega$, $C_L = 35\text{ pF}$, see figure 2 | Room | 228 | | 380 | | 380 | ns | |
| | | | Full | | | 450 | | 450 | | |
| Break-Before-Make Interval | t_{OPEN} | $V_{S1} = V_{S16} = 5\text{ V}$, $C_L = 35\text{ pF}$, $R_L = 1\text{ k}\Omega$, see figure 4 | Room | 115 | 40 | | 40 | | | |
| | | | Full | | | 10 | | 10 | | |
| Enable Turn-On Time | $t_{ON(EN)}$ | $V_{S1} = 5\text{ V}$, V_{S2} to $V_{S16} = 0\text{ V}$, $R_L = 1\text{ k}\Omega$, $C_L = 35\text{ pF}$ see figure 3 | Room | 197 | | 300 | | 300 | | |
| | | | Full | | | 420 | | 420 | | |
| Enable Turn-Off Time | $t_{OFF(EN)}$ | | Room | 46 | | 200 | | 200 | | |
| | | | Full | | | 220 | | 220 | | |
| Charge Injection ^e | Q_{INJ} | $C_L = 1\text{ nF}$, $R_{GEN} = 0\ \Omega$, $V_{GEN} = 0\text{ V}$ | Full | 4 | | | | | pC | |
| Off Isolation ^e | OIRR | $C_L = 5\text{ pF}$, $R_L = 50\ \Omega$ $f = 1\text{ MHz}$ | DG506B | Room | -86 | | | | dB | |
| | | | DG507B | | | -84 | | | | |
| Crosstalk ^e | X_{TALK} | $C_L = 5\text{ pF}$, $R_L = 50\ \Omega$ $f = 1\text{ MHz}$ | DG506B | Room | -85 | | | | dB | |
| | | | DG507B | | | -84 | | | | |
| - 3 dB Bandwidth ^e | BW | $R_L = 50\ \Omega$ | DG506B | Room | 104 | | | | MHz | |
| | | | DG507B | | | 191 | | | | |
| Total Harmonic Distortion ^e | THD | $R_L = 10\text{ k}\Omega$, 5 V_{RMS} , $f = 20\text{ Hz}$ to 20 kHz | Room | 0.23 | | | | | % | |

| SPECIFICATIONS Single Supply 12 V | | | | | | | | | | | | |
|-------------------------------------|--------------|---|-------------------|-------------------|--------------------|-------------------|------------------------------|-----|-----------------------------|----|--------|----|
| Parameter | Symbol | Test Conditions Unless Otherwise Specified $V_+ = 12\text{ V}$, $V_- = 0\text{ V}$ ($\pm 10\%$) V_{AX} , $V_{EN} = 2.4\text{ V}$, 0.8 V^a | | | Temp. ^b | Typ. ^c | A Suffix -40 °C to 125 °C | | D Suffix -40 °C to 85 °C | | Unit | |
| | | Min. ^d | Max. ^d | Min. ^d | | | Max. ^d | | | | | |
| Dynamic Characteristics | | | | | | | | | | | | |
| Source Off Capacitance ^e | $C_{S(off)}$ | f = 1 MHz | Room | 4 | | | | | | pF | | |
| Drain Off Capacitance ^e | $C_{D(off)}$ | | | | | | | | | | DG506B | 37 |
| | | | | | | | | | | | DG507B | 20 |
| Channel On Capacitance ^e | $C_{D(on)}$ | | | | | | | | | | DG506B | 43 |
| | | DG507B | 26 | | | | | | | | | |
| Power Supply | | | | | | | | | | | | |
| Power Supply Current | I+ | V_{AX} , $V_{EN} = 0\text{ V}$, or 5 V | Room | 0.005 | | 0.1 | | 0.1 | | mA | | |
| | | | Full | | | 0.1 | | 0.1 | | | | |

Notes:

- a. V_{AX} , V_{EN} = input voltage perform proper function.
- b. Room = 25 °C, Full = as determined by the operating temperature suffix.
- c. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
- d. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this datasheet.
- e. Guaranteed by design, not subject to production test.
- f. $\Delta R_{DS(on)} = R_{DS(on)} \text{ max.} - R_{DS(on)} \text{ min.}$

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

SCHEMATIC DIAGRAM Typical Channel

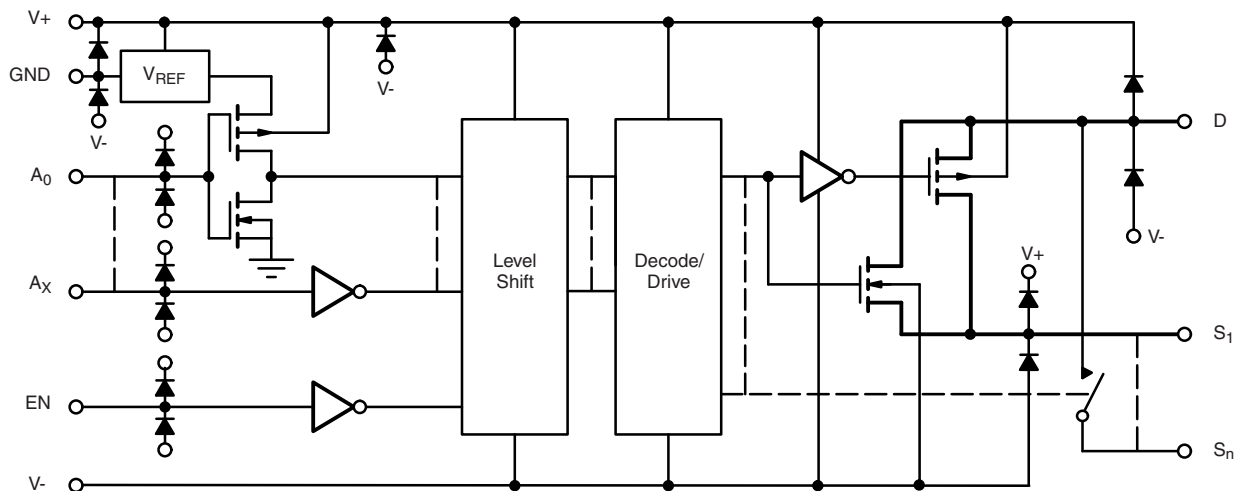
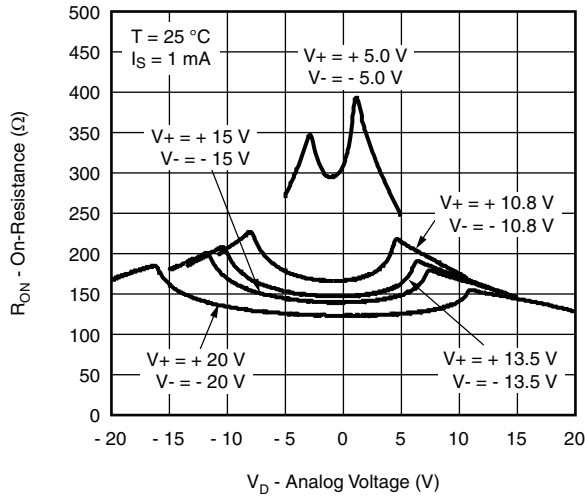
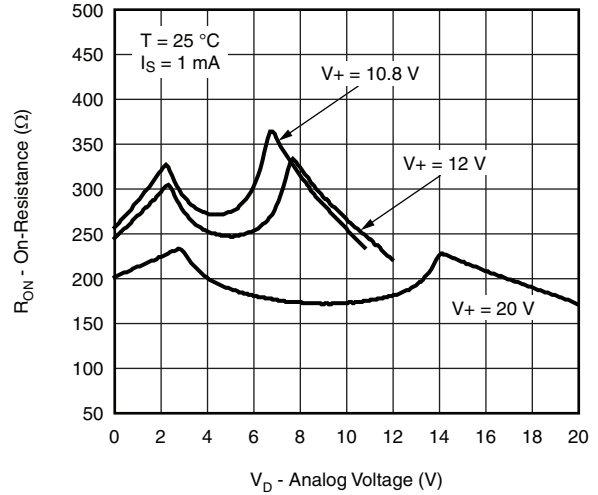


Figure 1.

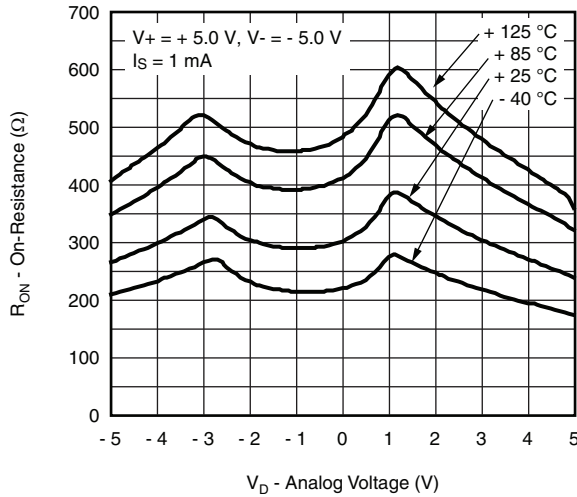
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



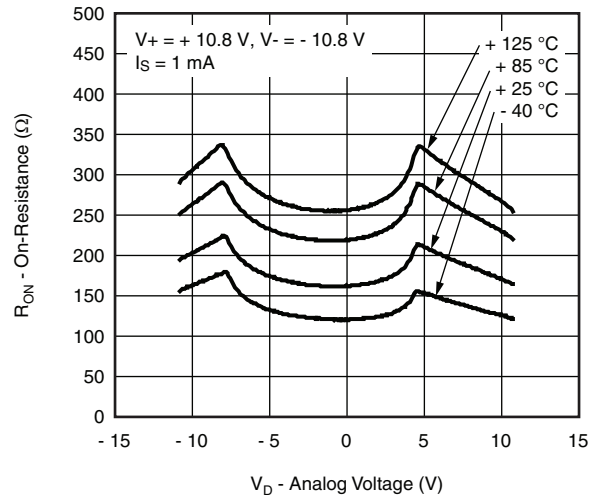
On-Resistance vs. V_D and Dual Supply Voltage



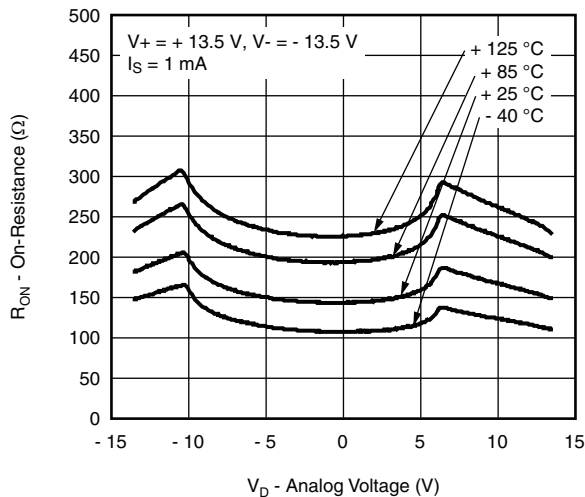
On-Resistance vs. V_D and Single Supply Voltage



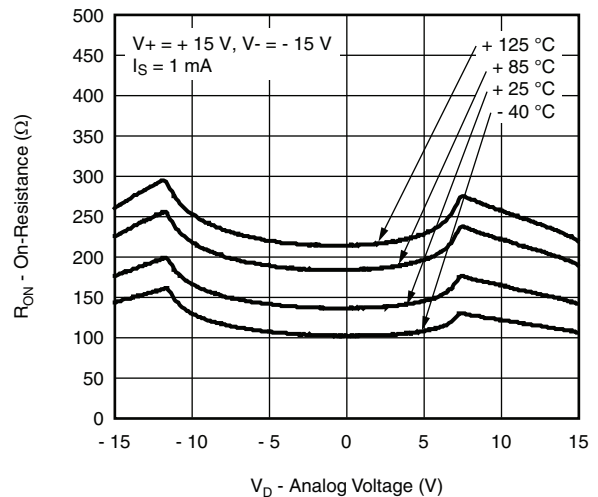
On-Resistance vs. Analog Voltage and Temperature



On-Resistance vs. Analog Voltage and Temperature

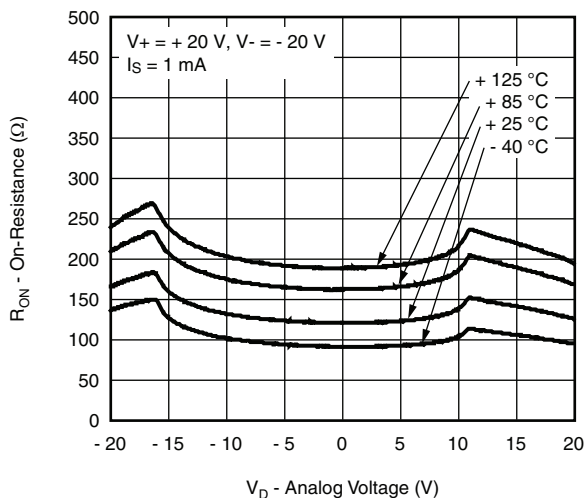


On-Resistance vs. Analog Voltage and Temperature

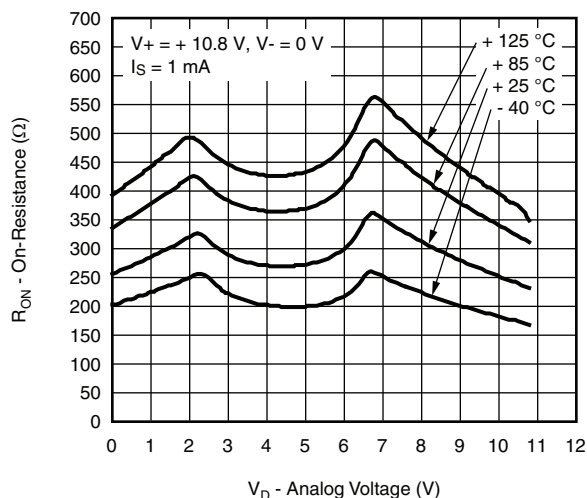


On-Resistance vs. Analog Voltage and Temperature

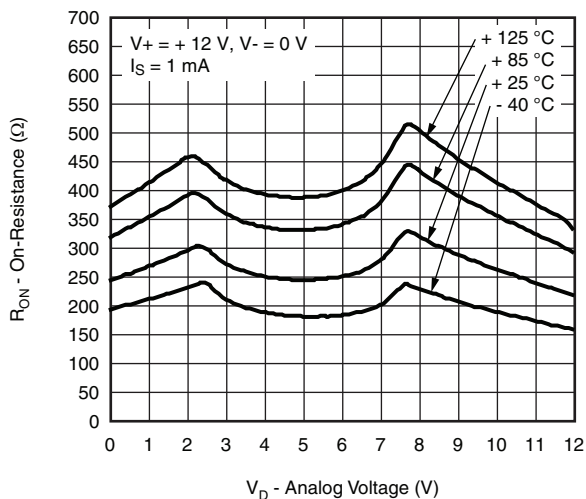
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



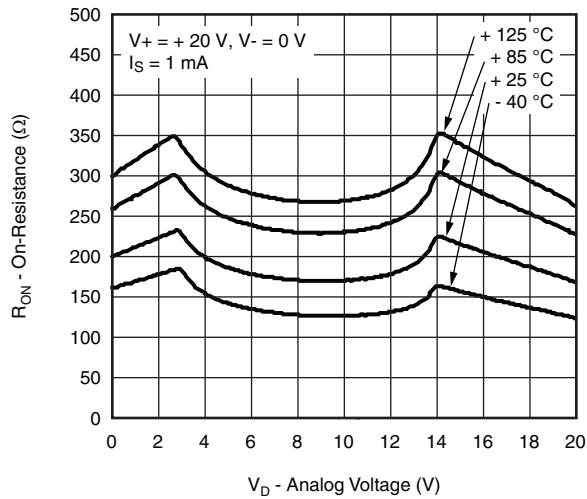
On-Resistance vs. Analog Voltage and Temperature



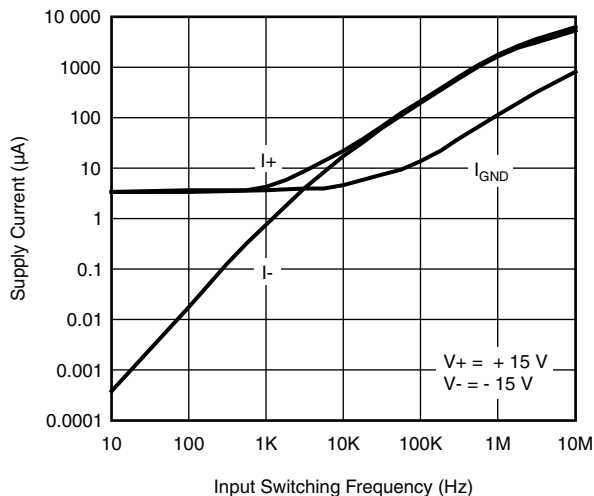
On-Resistance vs. Analog Voltage and Temperature



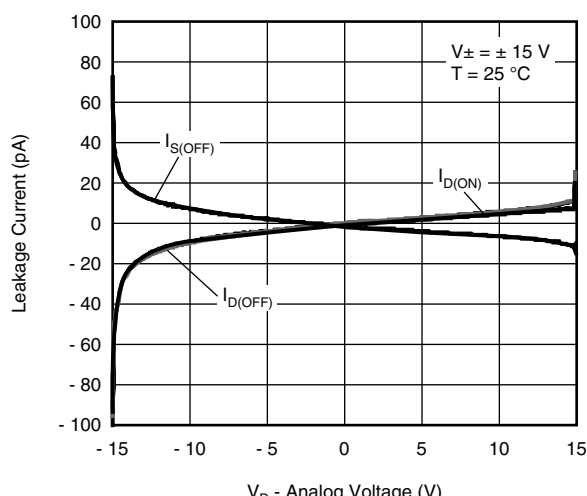
On-Resistance vs. Analog Voltage and Temperature



On-Resistance vs. Analog Voltage and Temperature

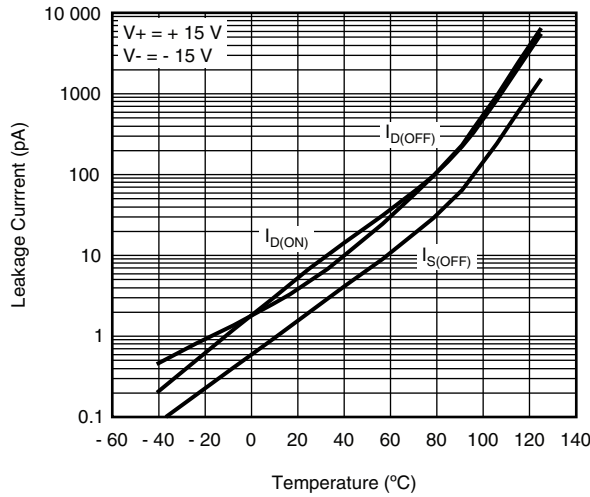


Supply Current vs. Input Switching Frequency

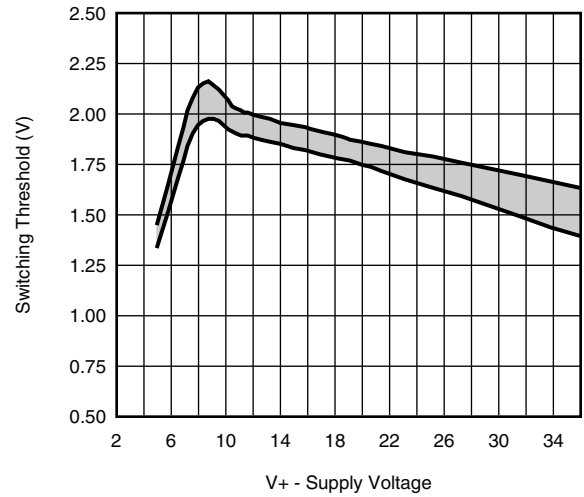


Leakage Current vs. Analog Voltage

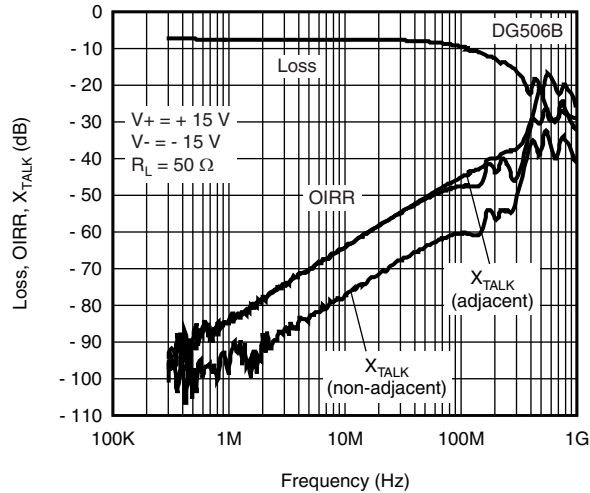
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



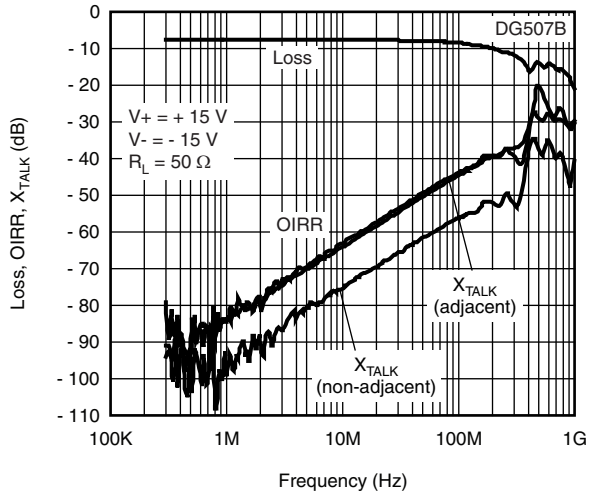
Leakage Current vs. Temperature



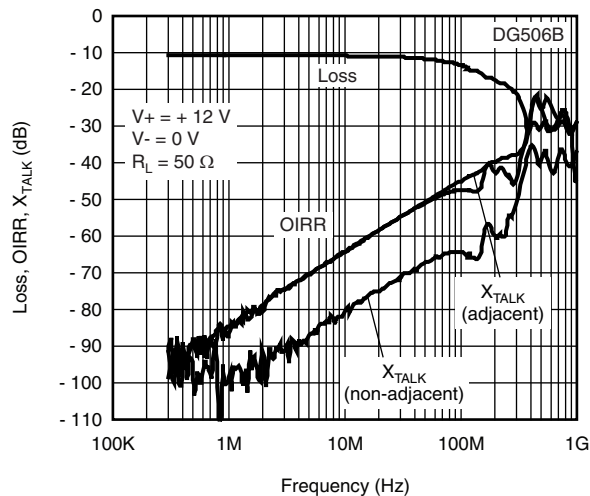
Switching Threshold vs. Single Supply V



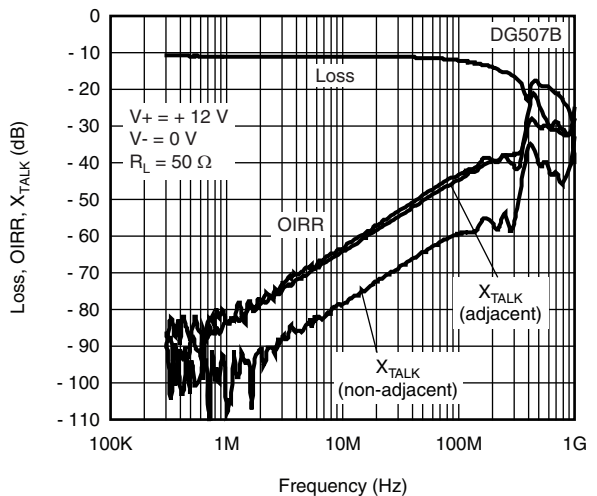
Insertion Loss, Off-Isolation, Crosstalk vs. Frequency



Insertion Loss, Off-Isolation, Crosstalk vs. Frequency

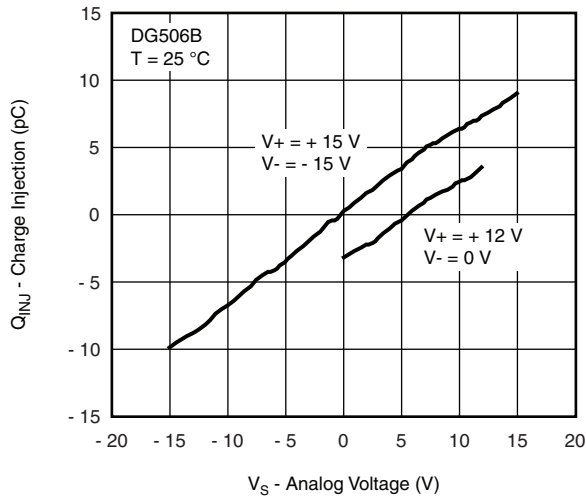


Insertion Loss, Off-Isolation, Crosstalk vs. Frequency

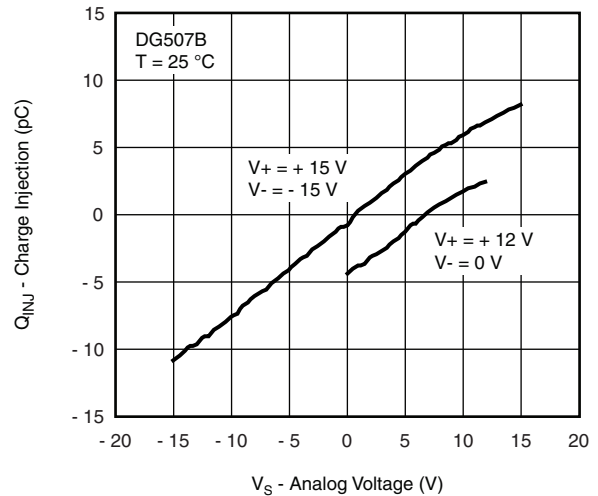


Insertion Loss, Off-Isolation, Crosstalk vs. Frequency

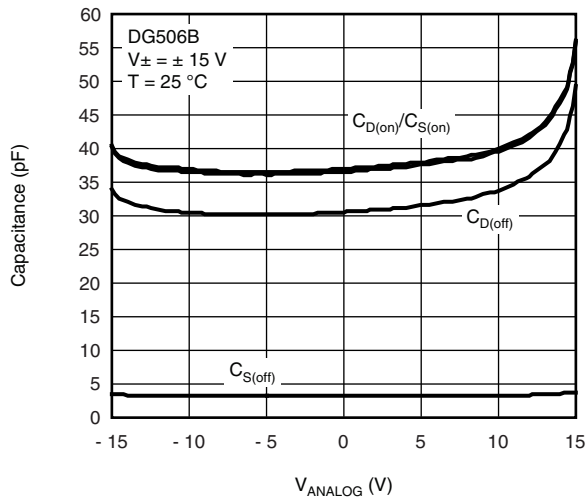
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



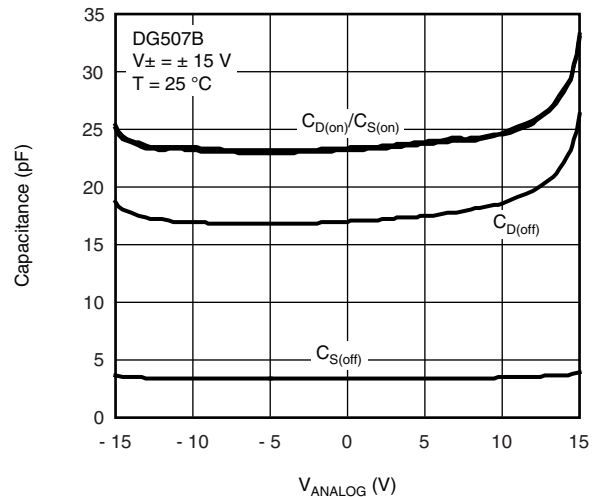
Charge Injection vs. Analog Voltage



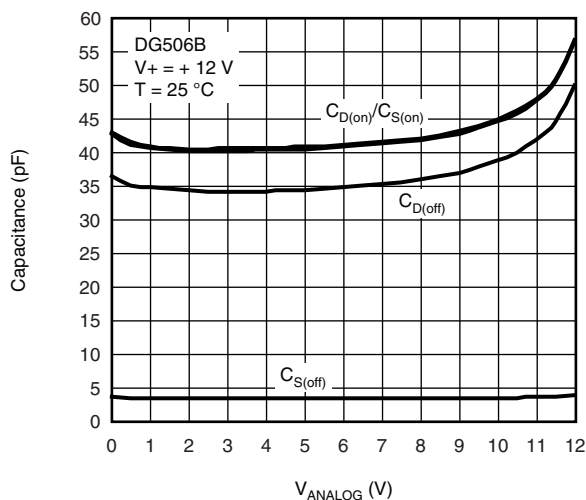
Charge Injection vs. Analog Voltage



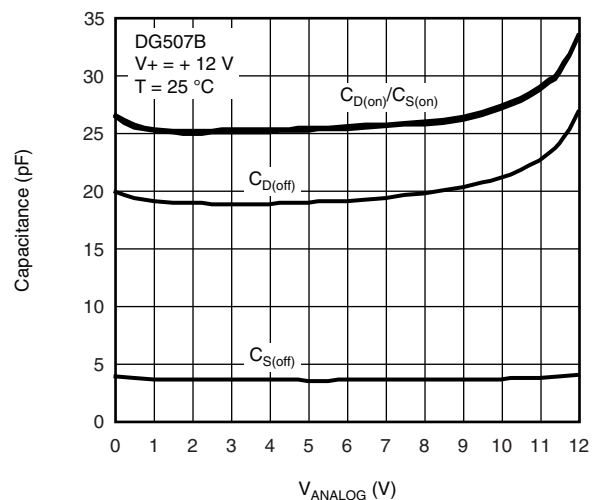
Capacitance vs. V_{ANALOG}



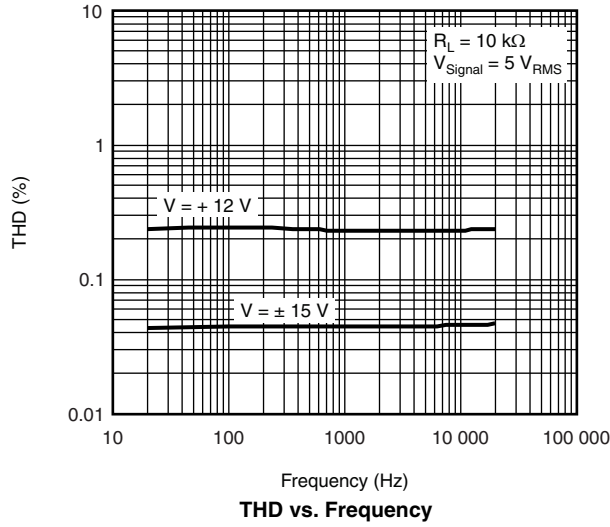
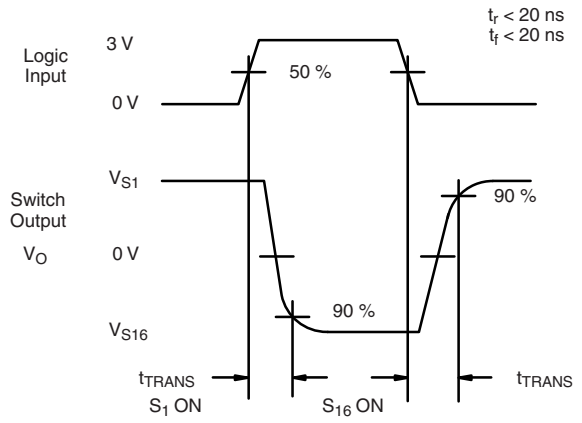
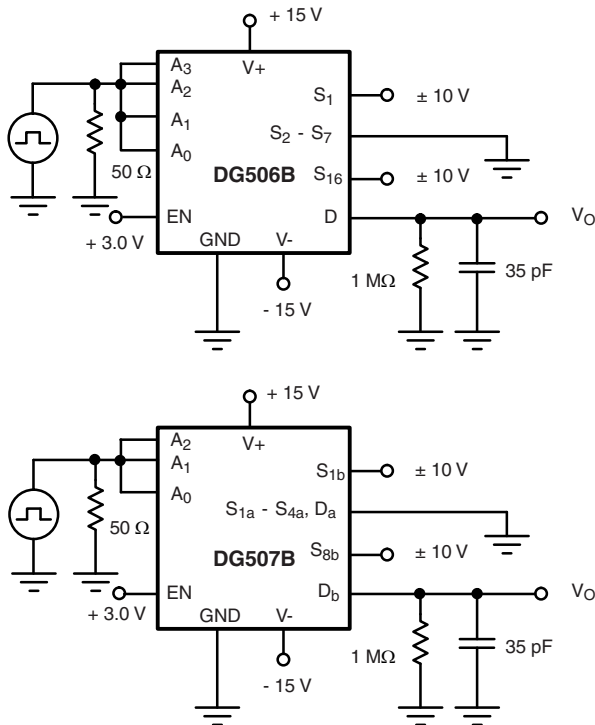
Capacitance vs. V_{ANALOG}



Capacitance vs. V_{ANALOG}



Capacitance vs. V_{ANALOG}

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

TEST CIRCUITS

Figure 2. Transition Time

TEST CIRCUITS

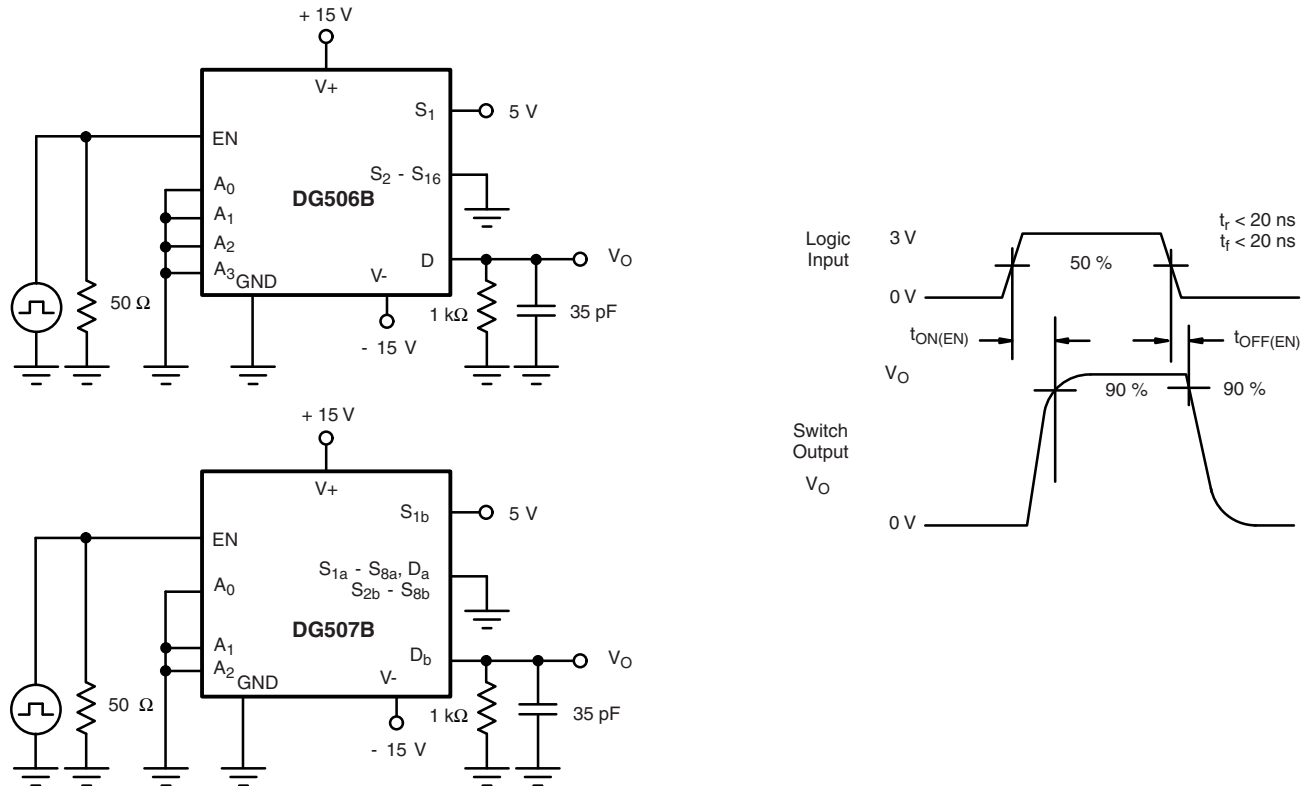


Figure 3. Enable Switching Time

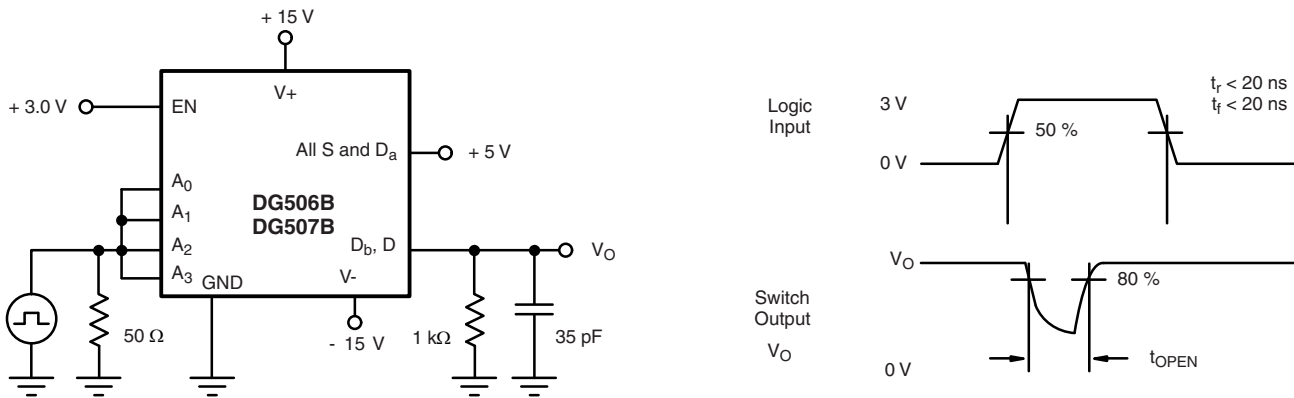
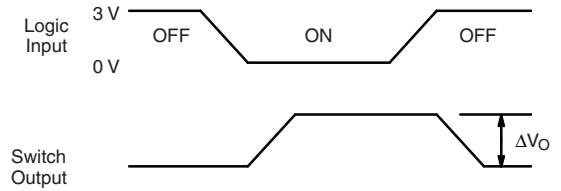
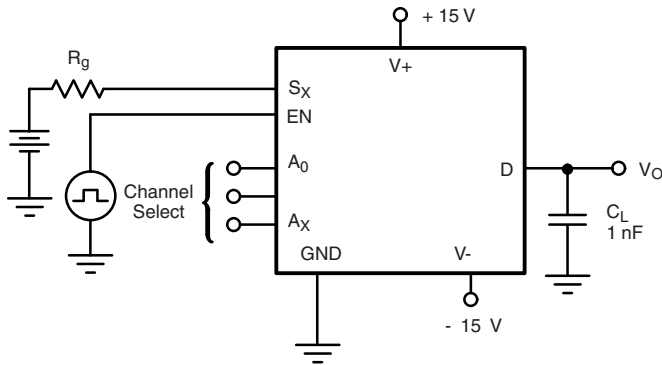
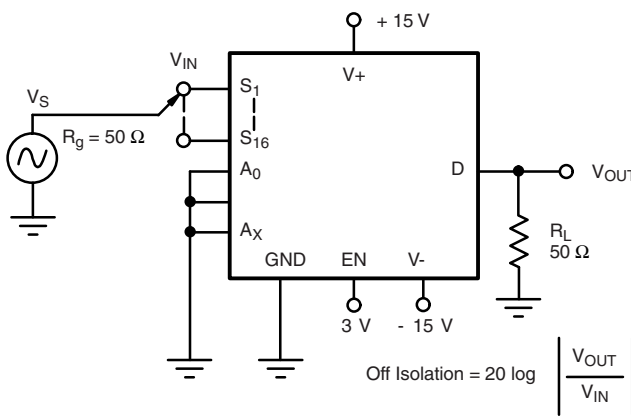
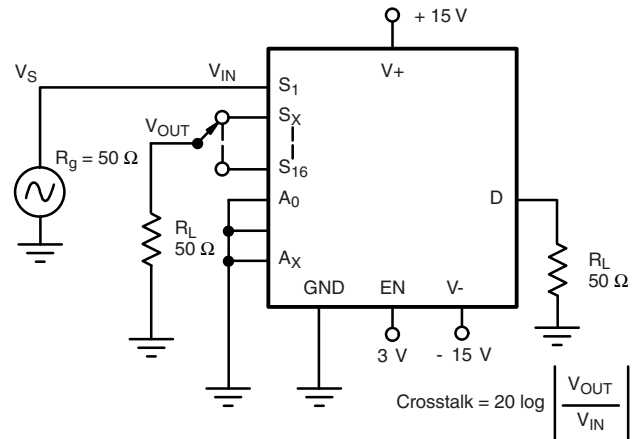
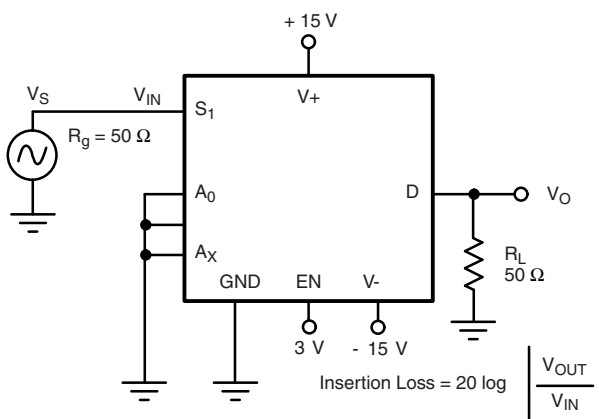
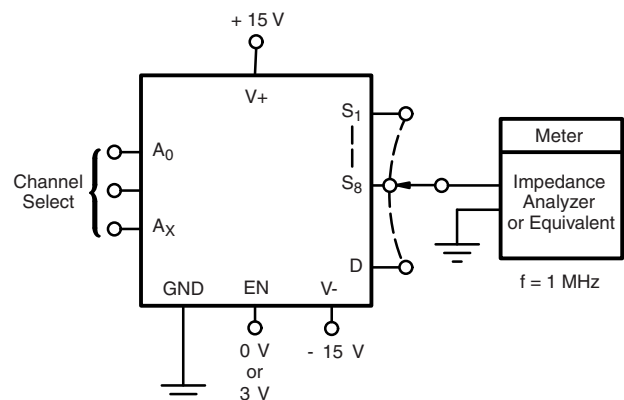


Figure 4. Break-Before-Make Interval

TEST CIRCUITS


ΔV_O is the measured voltage due to charge transfer error Q , when the channel turns off.

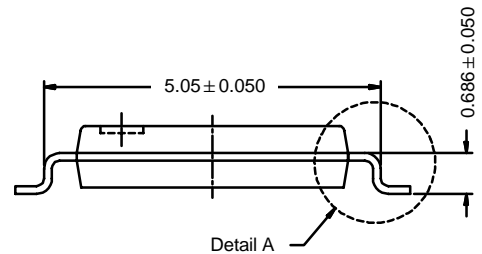
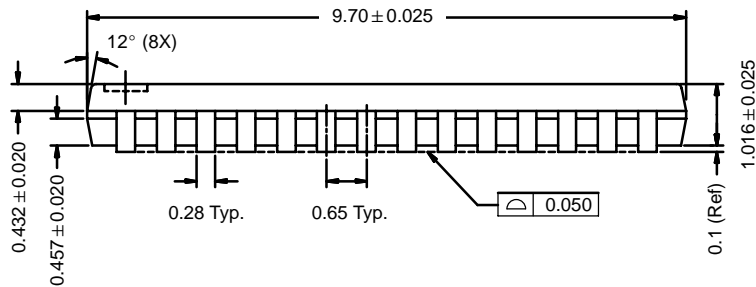
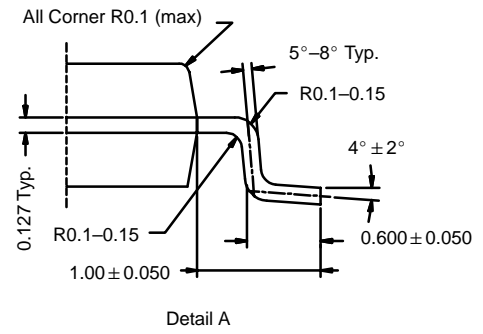
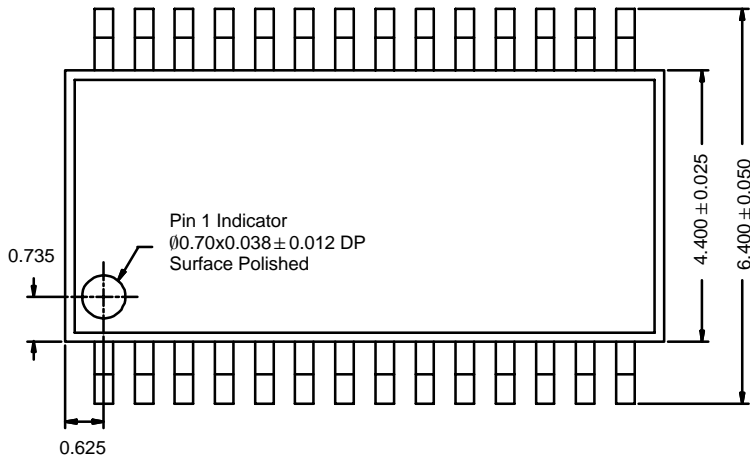
$$Q_{INJ} = C_L \times \Delta V_O$$

Figure 5. Charge Injection

Figure 6. Off Isolation

Figure 7. Crosstalk

Figure 8. Insertion Loss

Figure 9. Source Drain Capacitance

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65150.



TSSOP: 28-LEAD

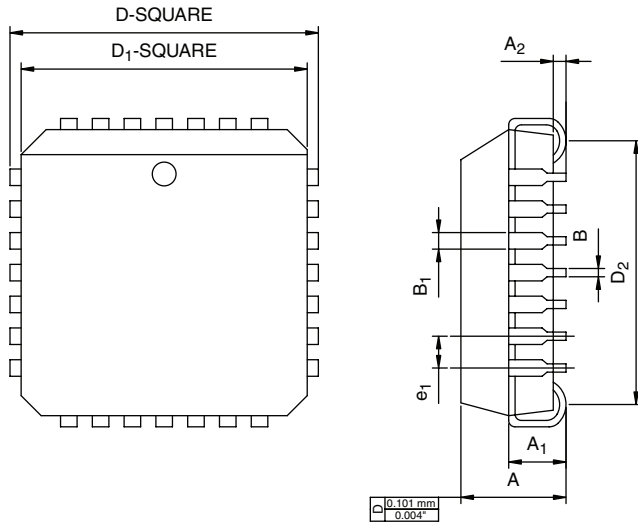


ECN: S-03946—Rev. C, 09-Jul-01
DWG: 5851

NOTES:

1. Package Surface: Shiny Finish (Ro 0.15 – 0.20).
2. Package Warp: 0.012 (max).
3. Package Corner Radius: R0.1 mm (max).
4. Top to BTM Cavity Mismatch: 0.037 (max).
5. Tolerance: ± 0.050 unless otherwise specified.
6. End Flash Max: 0.1016 mm.

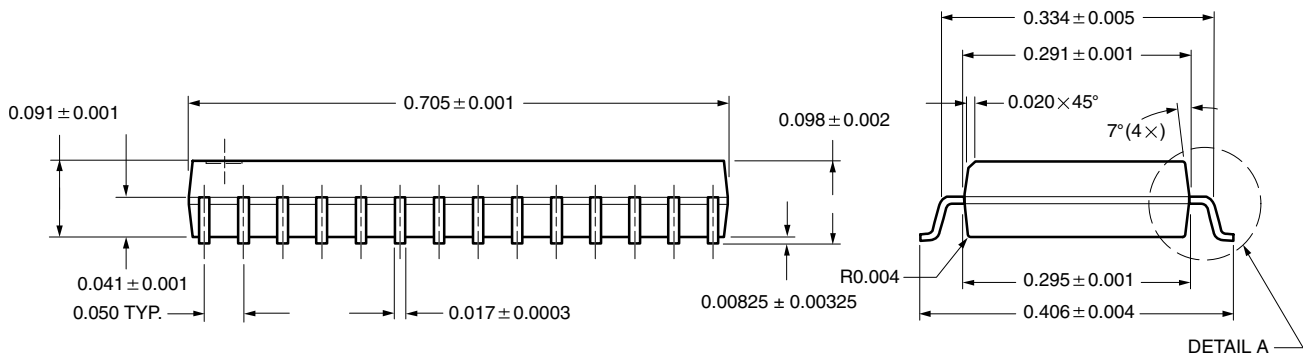
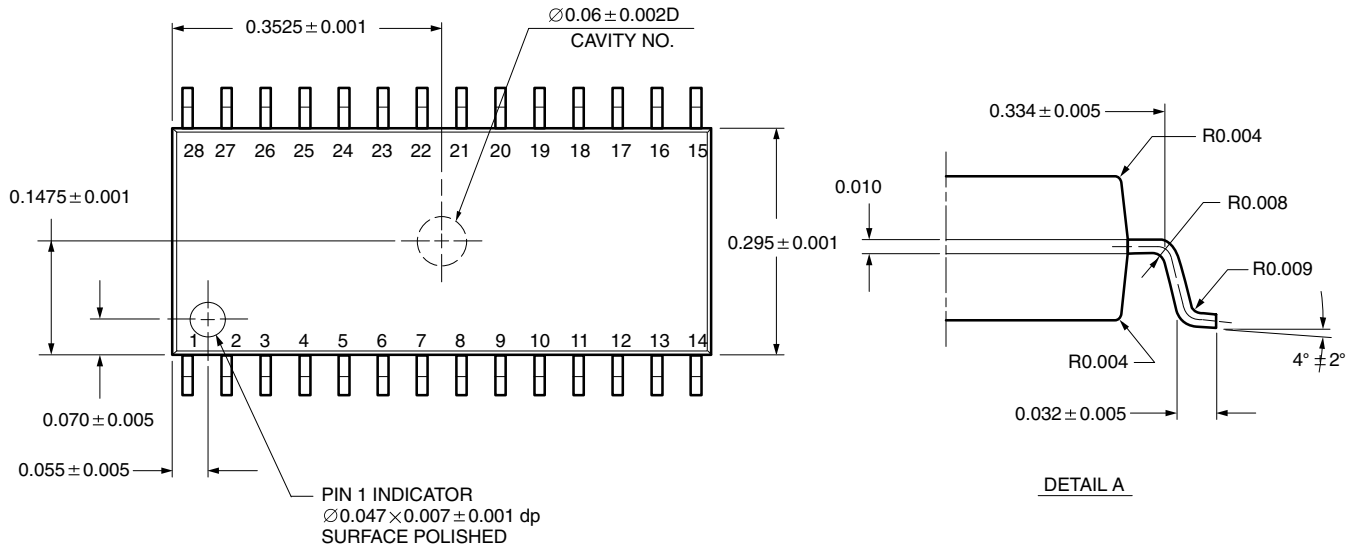
PLCC: 28-LEAD



| DIM. | MILLIMETERS | | INCHES | |
|--|-------------|--------|-----------|-------|
| | MIN. | MAX. | MIN. | MAX. |
| A | 4.20 | 4.57 | 0.165 | 0.180 |
| A ₁ | 2.29 | 3.04 | 0.090 | 0.120 |
| A ₂ | 0.51 | - | 0.020 | - |
| B | 0.331 | 0.553 | 0.013 | 0.021 |
| B ₁ | 0.661 | 0.812 | 0.026 | 0.032 |
| D | 12.32 | 12.57 | 0.485 | 0.495 |
| D ₁ | 11.430 | 11.582 | 0.450 | 0.456 |
| D ₂ | 9.91 | 10.92 | 0.390 | 0.430 |
| e ₁ | 1.27 BSC | | 0.050 BSC | |
| ECN: T09-0766-Rev. D, 28-Sep-09 DWG: 5491 | | | | |



SOIC (WIDE-BODY): 28-LEADS



All Dimensions In Inches

ECN: E11-2209-Rev. D, 01-Aug-11
DWG: 5850



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